

# RGW80TK65E

## 650V 40A Field Stop Trench IGBT

| V <sub>CES</sub>            | 650V                     |
|-----------------------------|--------------------------|
| I <sub>C (100°C)</sub>      | 23A                      |
| V <sub>CE(sat) (Typ.)</sub> | 1.5V@I <sub>C</sub> =40A |
| $P_D$                       | 81W                      |

#### Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating; RoHS Compliant

### Applications

**PFC** 

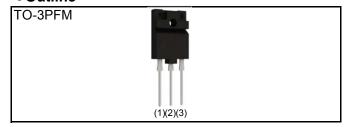
**UPS** 

Welding

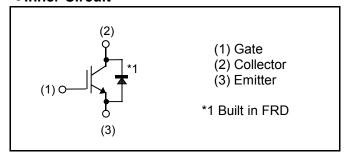
Solar Inverter

ΙH

#### Outline



### ●Inner Circuit



Packaging Specifications

|      | Packaging | Tube                      |            |  |
|------|-----------|---------------------------|------------|--|
|      |           | Reel Size (mm)            | -          |  |
| <br> | 20        | Tape Width (mm)           | -          |  |
| Туре | ρe        | Basic Ordering Unit (pcs) | 450        |  |
|      |           | Packing Code              | C11        |  |
|      |           | Marking                   | RGW80TK65E |  |

## ● Absolute Maximum Ratings (at T<sub>C</sub> = 25°C unless otherwise specified)

| Parameter                      |                        | Symbol             | Value       | Unit |  |
|--------------------------------|------------------------|--------------------|-------------|------|--|
| Collector - Emitter Voltage    |                        | V <sub>CES</sub>   | 650         | V    |  |
| Gate - Emitter Voltage         |                        | $V_{GES}$          | ±30         | V    |  |
| Collector Current              | T <sub>C</sub> = 25°C  | I <sub>C</sub>     | 39          | А    |  |
| Collector Current              | T <sub>C</sub> = 100°C | I <sub>C</sub>     | 23          | А    |  |
| Pulsed Collector Current       |                        | I <sub>CP</sub> *1 | 160         | А    |  |
| Diode Forward Current          | T <sub>C</sub> = 25°C  | I <sub>F</sub>     | 46          | А    |  |
|                                | T <sub>C</sub> = 100°C | I <sub>F</sub>     | 26          | А    |  |
| Diode Pulsed Forward Current   |                        | I <sub>FP</sub> *1 | 200         | А    |  |
| Power Dissipation              | T <sub>C</sub> = 25°C  | $P_{D}$            | 81          | W    |  |
|                                | T <sub>C</sub> = 100°C | $P_{D}$            | 40          | W    |  |
| Operating Junction Temperature |                        | T <sub>j</sub>     | -40 to +175 | °C   |  |
| Storage Temperature            |                        | T <sub>stg</sub>   | -55 to +175 | °C   |  |

<sup>\*1</sup> Pulse width limited by T<sub>imax</sub>.

### ●Thermal Resistance

| Parameter                                | Symbol            | Values |      |      | Unit  |
|--|-------------------|--------|------|------|-------|
| Farameter                                |                   | Min.   | Тур. | Max. | Offic |
| Thermal Resistance IGBT Junction - Case  | $R_{\theta(j-c)}$ | -      | -    | 1.85 | °C/W  |
| Thermal Resistance Diode Junction - Case | $R_{\theta(j-c)}$ | -      | -    | 1.83 | °C/W  |

# ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

| Parameter                                 | Symbol               | Conditions   | Values |             |          | Unit  |
|---|----------------------|--|--------|-------------|----------|-------|
| r arameter                                | Syllibol             | Conditions   | Min.   | Тур.        | Max.     | Offic |
| Collector - Emitter Breakdown<br>Voltage  | BV <sub>CES</sub>    | $I_{C} = 10 \mu A, V_{GE} = 0 V$                                   | 650    | 1           | ı        | ٧     |
| Collector Cut - off Current               | I <sub>CES</sub>     | V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V                       | ı      | 1           | 10       | μΑ    |
| Gate - Emitter Leakage Current            | I <sub>GES</sub>     | $V_{GE} = \pm 30V, V_{CE} = 0V$                                    | -      | -           | ±200     | nA    |
| Gate - Emitter Threshold<br>Voltage       | $V_{\text{GE(th)}}$  | $V_{CE} = 5V, I_{C} = 26.0 \text{mA}$                              | 5.0    | 6.0         | 7.0      | V     |
| Collector - Emitter Saturation<br>Voltage | V <sub>CE(sat)</sub> | $I_{C}$ = 40A, $V_{GE}$ = 15V<br>$T_{j}$ = 25°C<br>$T_{j}$ = 175°C | -      | 1.5<br>1.85 | 1.9<br>- | V     |

## ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

| Davamatar                        | Cymphal                     | Conditions                                    |             | Unit |      |       |
|----------------------------------|-----------------------------|---|-------------|------|------|-------|
| Parameter                        | Parameter Symbol Conditions |   | Min.        | Тур. | Max. | Offic |
| Input Capacitance                | C <sub>ies</sub>            | V <sub>CE</sub> = 30V                         | -           | 3320 | -    |       |
| Output Capacitance               | C <sub>oes</sub>            | V <sub>GE</sub> = 0V                          | -           | 83   | -    | pF    |
| Reverse Transfer Capacitance     | C <sub>res</sub>            | f = 1MHz                                      | -           | 60   | -    |       |
| Total Gate Charge                | $Q_g$                       | V <sub>CE</sub> = 400V                        | -           | 110  | -    |       |
| Gate - Emitter Charge            | $Q_{ge}$                    | I <sub>C</sub> = 40A                          | -           | 23   | -    | nC    |
| Gate - Collector Charge          | $Q_{gc}$                    | V <sub>GE</sub> = 15V                         | -           | 41   | -    |       |
| Turn - on Delay Time             | t <sub>d(on)</sub>          | I <sub>C</sub> = 40A, V <sub>CC</sub> = 400V  | -           | 44   | -    |       |
| Rise Time                        | t <sub>r</sub>              | $V_{GE} = 15V, R_G = 10\Omega$                | -           | 17   | -    |       |
| Turn - off Delay Time            | t <sub>d(off)</sub>         | T <sub>j</sub> = 25°C                         | -           | 143  | -    | ns    |
| Fall Time                        | t <sub>f</sub>              | Inductive Load                                | -           | 34   | -    |       |
| Turn - on Switching Loss         | E <sub>on</sub>             | *E <sub>on</sub> includes diode               | -           | 0.76 | -    |       |
| Turn - off Switching Loss        | E <sub>off</sub>            | reverse recovery                              | -           | 0.72 | -    | mJ    |
| Turn - on Delay Time             | t <sub>d(on)</sub>          | I <sub>C</sub> = 40A, V <sub>CC</sub> = 400V  | -           | 41   | -    |       |
| Rise Time                        | t <sub>r</sub>              | $V_{GE} = 15V, R_G = 10\Omega$                | -           | 18   | -    | no    |
| Turn - off Delay Time            | t <sub>d(off)</sub>         | T <sub>j</sub> = 175°C                        | -           | 158  | -    | ns    |
| Fall Time                        | t <sub>f</sub>              | Inductive Load                                | -           | 70   | -    |       |
| Turn - on Switching Loss         | E <sub>on</sub>             | *E <sub>on</sub> includes diode               | -           | 0.76 | -    |       |
| Turn - off Switching Loss        | E <sub>off</sub>            | reverse recovery                              | -           | 0.91 | -    | mJ    |
|                                  |                             | I <sub>C</sub> = 160A, V <sub>CC</sub> = 520V |             |      |      |       |
| Reverse Bias Safe Operating Area | RBSOA                       | V <sub>P</sub> = 650V, V <sub>GE</sub> = 15V  | FULL SQUARE |      |      | -     |
| 1                                |                             | $R_G = 100\Omega, T_j = 175^{\circ}C$         |             |      |      |       |

# ●FRD Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

| Parameter                              | Symbol          | Conditions  | Values |              |          | Unit  |
|--|-----------------|---|--------|--------------|----------|-------|
| Parameter                              |                 |   | Min.   | Тур.         | Max.     | Offic |
| Diode Forward Voltage                  | V <sub>F</sub>  | $I_F = 50A$ $T_j = 25$ °C $T_j = 175$ °C                                | -      | 1.45<br>1.55 | 1.9<br>- | V     |
| Diode Reverse Recovery Time            | t <sub>rr</sub> |   | -      | 102          | -        | ns    |
| Diode Peak Reverse Recovery<br>Current | I <sub>rr</sub> | $I_F = 50A$ $V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$  | 1      | 11.2         | 1        | А     |
| Diode Reverse Recovery<br>Charge       | $Q_{rr}$        |   | -      | 0.64         | -        | μC    |
| Diode Reverse Recovery Energy          | E <sub>rr</sub> |   | -      | 29.5         | -        | μJ    |
| Diode Reverse Recovery Time            | t <sub>rr</sub> | $I_F = 50A$ $V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 175^{\circ}C$ | 1      | 177          | 1        | ns    |
| Diode Peak Reverse Recovery<br>Current | I <sub>rr</sub> |   | 1      | 15.2         | 1        | Α     |
| Diode Reverse Recovery<br>Charge       | $Q_{rr}$        |   | -      | 1.62         | -        | μC    |
| Diode Reverse Recovery Energy          | E <sub>rr</sub> |   | -      | 104.8        | -        | μJ    |

Fig.1 Power Dissipation vs. Case Temperature

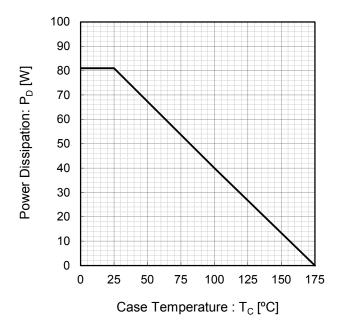


Fig.2 Collector Current vs. Case Temperature

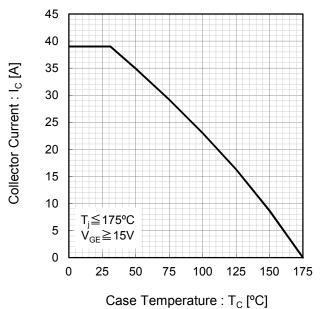


Fig.3 Forward Bias Safe Operating Area

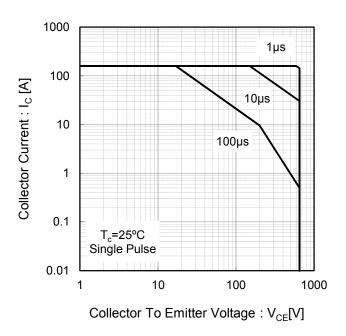


Fig.4 Reverse Bias Safe Operating Area

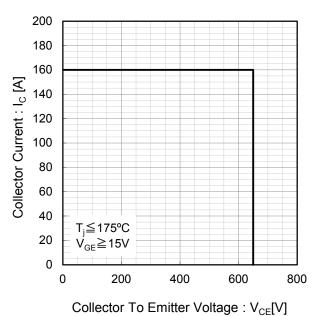


Fig.5 Typical Output Characteristics

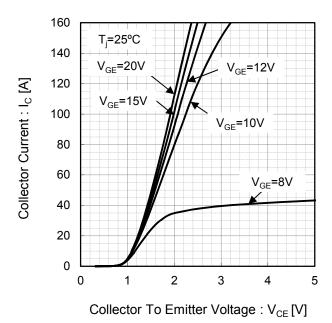
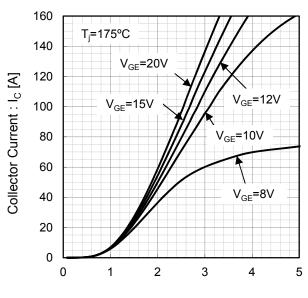


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V<sub>CE</sub> [V]

Fig.7 Typical Transfer Characteristics

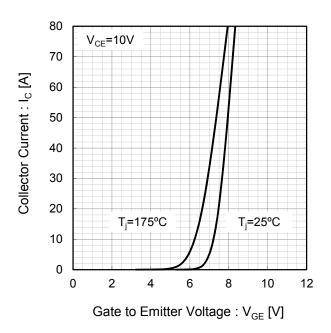


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

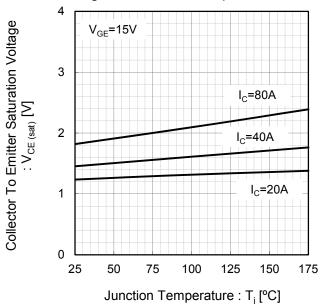
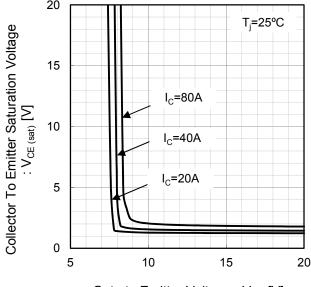
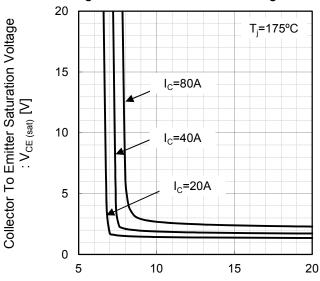


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage :  $V_{GE}[V]$ 

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage : V<sub>GE</sub> [V]

Fig.11 Typical Switching Time vs. Collector Current

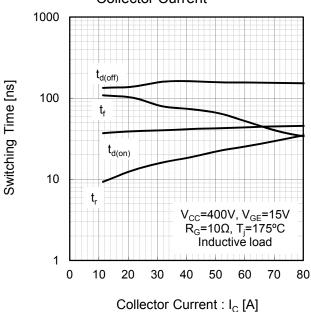
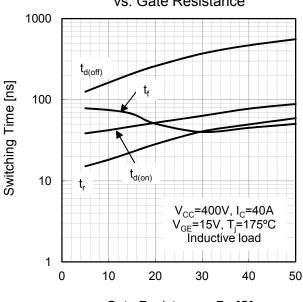


Fig.12 Typical Switching Time vs. Gate Resistance



Gate Resistance :  $R_{G}\left[\Omega\right]$ 

Fig.13 Typical Switching Energy Losses vs. Collector Current

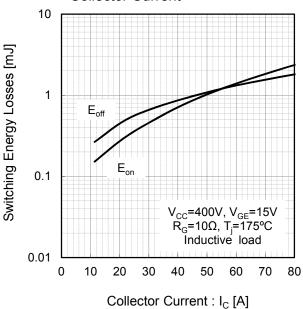


Fig.14 Typical Switching Energy Losses vs. Gate Resistance

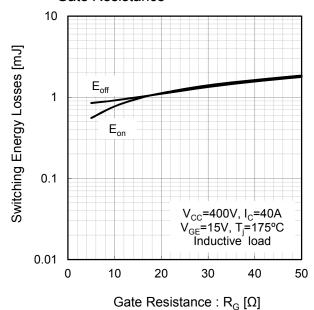


Fig.15 Typical Capacitance vs.
Collector To Emitter Voltage

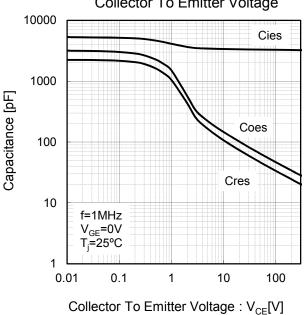


Fig.16 Typical Gate Charge

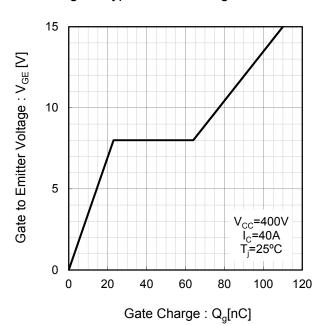


Fig.17 Typical Diode Forward Current vs. Forward Voltage 200 180 160 Forward Current : I<sub>F</sub> [A] 140 120 100 T<sub>i</sub>=25°C 80 T<sub>i</sub>=175°C 60 40 20 0 0 1 2 3 5 Forward Voltage : V<sub>F</sub>[V]

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400 Reverse Recovery Time : t<sub>rr</sub> [ns] 300 200 T<sub>i</sub>=175°C 100  $V_{CC}$ =400V di<sub>F</sub>/dt=200A/µs T<sub>i</sub>=25°C Inductive load 0 20 30 40 50 60 70 80 90 100 0 10 Forward Current: I<sub>F</sub> [A]

Fig. 19 Typical Diode Reverse Recovery Current vs. Forward Current

Tj=175°C

Tj=175°C

Tj=25°C

V<sub>CC</sub>=400V

di<sub>F</sub>/dt=200A/µs

Inductive load

0 10 20 30 40 50 60 70 80 90 100

Forward Current : I<sub>F</sub> [A]

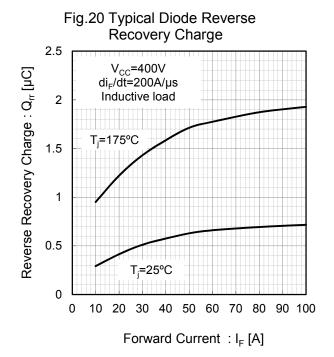


Fig.21 Typical IGBT Transient Thermal Impedance

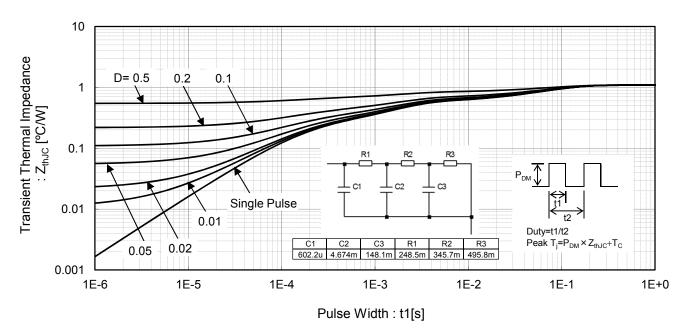
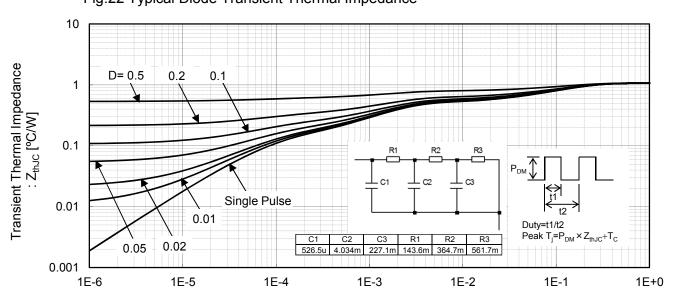


Fig.22 Typical Diode Transient Thermal Impedance



### ●Inductive Load Switching Circuit and Waveform

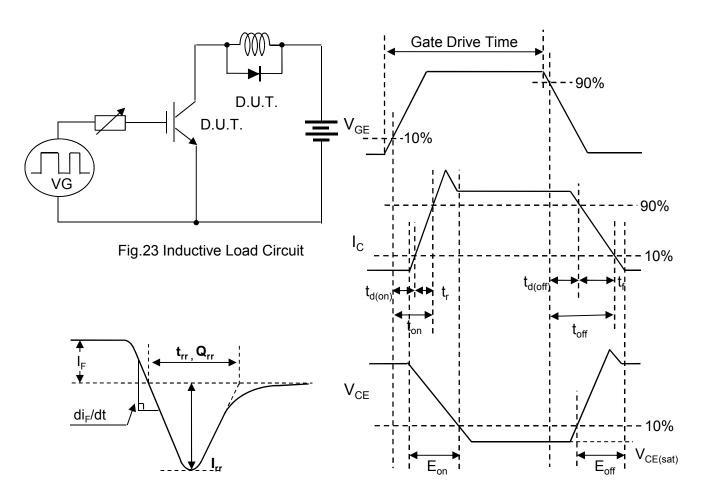


Fig.25 Diode Reverce Recovery Waveform

Fig.24 Inductive Load Waveform

#### Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

  Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact us.

## ROHM Customer Support System

http://www.rohm.com/contact/